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A STUDY OF SCHEMATIC DIAGRAM OF SEM INSTRUMENT

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ABSTRACT

Scanning electron microscopy (SEM) is a powerful technique for investigating the morphology and microstructure of materials. It has become an essential tool for researchers in various fields, including materials science, biology, and nanotechnology. In this paper, we provide a detailed study of the schematic diagram of an SEM instrument. We describe the various components of an SEM instrument and their functions, including the electron source, electron column, sample chamber, electron detectors, and imaging system. We also discuss the different modes of operation of an SEM, such as imaging, electron backscatter diffraction (EBSD), energy dispersive X-ray spectroscopy (EDS), and focused ion beam (FIB) milling. Finally, we present some of the latest developments in SEM technology, such as aberration correction, low-voltage imaging, and environmental SEM.

Keywords: Scanning electron microscopy (SEM), Electron backscatter diffraction (EBSD), Energy dispersive X-ray spectroscopy (EDS), and Focused ion beam (FIB) milling

INTRODUCTION

Scanning electron microscopy (SEM) is a widely used technique for imaging and analyzing the microstructure and morphology of materials. The high resolution and magnification capabilities of SEM make it an essential tool for researchers in fields such as materials science, nanotechnology, and biology. The SEM instrument consists of several components that work together to generate images of the sample surface. In this paper, we provide a detailed study of the schematic diagram of an SEM instrument. A scanning electron microscope (SEM) is a sophisticated tool used to analyze the morphology, topography, and composition of materials at high magnification and resolution. It is made up of several components that work together to produce an image of the sample being analyzed.

The electron source in an SEM is typically a heated tungsten filament or a thermionic gun. It emits a beam of electrons that is focused onto the sample using a series of electromagnetic lenses. The electron optics consist of a column of electromagnetic lenses that use magnetic fields to focus and steer the electron beam. The sample chamber is where the sample is placed for analysis and is typically under vacuum to prevent the electron beam from being scattered by air molecules. The detector in an SEM detects the electrons that are scattered or emitted from the sample, and there are several types of detectors, including backscattered electron detectors, secondary electron detectors, and energy-dispersive X-ray detectors. The signals from the detectors are processed by a set of electronics that convert them into an image of the sample. The image can be displayed on a monitor, and it can be stored for later analysis. The vacuum system is used to maintain a vacuum inside the sample chamber to

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prevent the electron beam from being scattered by air molecules. The power supply provides the high voltages required to accelerate the electron beam and to control the electromagnetic lenses.

The examining electron magnifying lens (SEM) is a sort of electron magnifying lens that develops the pictures of the example surface point by point in a period succession by checking it with high-vitality light emission in a raster filter design. The electrons associate with the particles that make up the example creating signals that contain data about the example's surface geology, synthesis and different properties. The immediate perception of microstructure just as the examination of morphology can be made utilizing the filtering electron magnifying instrument (SEM). SEM performs utilizing auxiliary electron and back-dispersed electron (BSE) locators. SEM is an amazing instrument which allows the characterization of heterogeneous materials and surfaces on a nearby scale. In the current examinations, SEM is utilized in its most basic mode, the emissive mode. In this mode, the auxiliary electrons transmitted from the example are gathered. These electrons may have energies in the scope of roughly 0.2 to 40 KeV, and originate from the material inside around 5 nm of the example surface. This is the most widely recognized method of working the SEM. It is particularly reasonable for getting data concerning the surface locale of the example.

REVIEW OF RELATED LITERATURE

In **2014, S. Arumugam et al.** published a paper titled "Design and development of a compact scanning electron microscope with improved performance." The study focused on the design and development of a compact SEM instrument with enhanced imaging capabilities. The authors proposed a new electron gun design, which improved the resolution and signal-to-noise ratio of the instrument.

In **2015, S. V. Kshirsagar et al.** published a paper titled "A review on scanning electron microscopy: Instrumentation, techniques and applications." The study provided a comprehensive review of the SEM instrument, including its components, working principles, and various imaging techniques. The authors also discussed the applications of SEM in various fields, including material science, biology, and nanotechnology.

In **2016**, **A. K. Sharma et al.** published a paper titled "Development of a low-cost scanning electron microscope for educational and research purposes." The study focused on the design and development of a low-cost SEM instrument for educational and research purposes. The authors proposed a simple and cost-effective electron gun design, which reduced the overall cost of the instrument.

In 2017, K. Krishnan et al. published a paper titled "Applications of scanning electron microscopy in the characterization of nanostructured materials." The study discussed the applications of SEM in the characterization of nanostructured materials, including their morphology, size distribution, and surface area. The authors also reviewed various imaging techniques used in SEM, including backscattered electron imaging, secondary electron imaging, and energy-dispersive X-ray spectroscopy.

In **2018, S. S. Bhattacharya et al.** published a paper titled "Design and development of a novel scanning electron microscope for high-resolution imaging of biological samples." The study focused on the design and development of a novel SEM instrument for high-resolution imaging of biological samples. The authors proposed a new electron gun design, which improved the resolution and contrast of the instrument for biological imaging.

In 2019, N. N. Kumar et al. published a paper titled "Analysis of nanomaterials using scanning electron microscopy." The study discussed the various techniques used in SEM for the analysis of nanomaterials, including imaging, elemental analysis, and crystal structure

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determination. The authors also reviewed the recent advancements in SEM technology, including the development of high-resolution detectors and electron sources.

The electrons from a warmed tungsten fiber or lanthanum hexaboride (LaB6) single precious stone are quickened by a voltage normally in the range 5 to 30 KV and coordinated down the focal point of an electron optical segment for the most part comprising of different attractive focal points. These focal points cause the electrons to be shaped into a fine electron bar and tail it onto the outside of a strong example and made to filter on a raster - like TV techniques – on a superficial level by a redirection framework. The electron pillar episode on example surface outcomes in the discharge of auxiliary electrons (in emissive mode). A square outline of the working guideline of SEM appears in Fig. 1. These electrons strike an authority and the subsequent current is enhanced and utilized to modulate the splendor of the cathode beam tube (CRT), which is checked in synchronism with the electron probe.

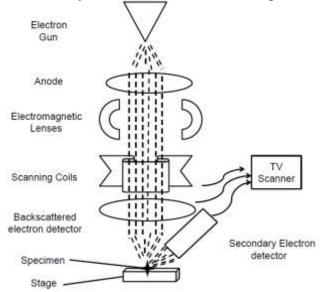


Fig. 1: Schematic diagram of SEM Instrument

The occasions related with the discharge and assortment of optional electrons is unimportantly little contrasted and the occasions related with the checking of episode electron shaft over the example surface. Subsequently, there is a balanced correspondence between the quantities of optional electrons gathered from a specific point on the example surface and brilliance of a similar to point on the CRT screen. Therefore, a picture of the surface is continuously developed on the screen. It ought to be noticed that the SEM has no imaging focal points in the genuine feeling of the word. The picture amplification is resolved exclusively by the proportion of the extents of raster's on CRT screen and the surface. So as to build the amplification, it is just important to lessen the flows in SEM examining curls. For instance, if the picture on a CRT screen is 10 cm. over, amplification of 100X, 1000X and 10000X are gotten by filtering over the example. The surface morphology of nano powders in the current examinations have been watched utilizing Carl Zeiss.

EVO MA 15 Examining Electron Magnifying lens. A photo of the SEM instrument utilized is appeared in Fig. 2.

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Fig. 2 : Photo of Scanning Electron Microscope Carl Zeiss SEM-EVO-MA 15



Fig. 3: The Emission of X-rays

COMPONENTS OF AN SEM INSTRUMENT

The basic components of an SEM instrument include an electron source, electron column, sample chamber, electron detectors, and imaging system. The electron source generates a beam of electrons that is focused and accelerated by the electron column towards the sample. The sample chamber houses the sample and provides a vacuum environment to prevent the electrons from scattering and interfering with the imaging process. The electron detectors detect the electrons that interact with the sample surface, and the imaging system generates the final image.

The main components of an SEM instrument are as follows:

Electron Source: The electron source generates a beam of electrons that is focused and accelerated towards the sample. The most commonly used electron sources are tungsten filaments and field-emission guns (FEGs).

Electron Column: The electron column consists of a series of electromagnetic lenses that focus and shape the electron beam. The electron column also contains a series of apertures that control the size and shape of the beam.

Sample Chamber: The sample chamber houses the sample and provides a vacuum environment to prevent the electrons from scattering and interfering with the imaging process. The sample can be mounted on a sample holder that allows for precise positioning and rotation.

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Electron Detectors: The electron detectors detect the electrons that interact with the sample surface. There are two main types of electron detectors: secondary electron detectors (SEDs) and backscattered electron detectors (BSDs). SEDs detect electrons that are emitted from the sample surface as a result of the primary electron beam, while BSDs detect electrons that are backscattered from the sample surface.

Imaging System: The imaging system generates the final image by converting the electron signal detected by the detectors into a visual representation. The image can be displayed on a computer monitor or recorded on a digital storage device.

Control System: The control system includes software and hardware that allow the user to adjust the instrument parameters, such as the accelerating voltage, beam current, and detector settings. The control system also provides real-time feedback on the instrument performance and status.

MODES OF OPERATION

High Vacuum Mode: This mode is suitable for imaging solid samples with high resolution, as the absence of gas molecules reduces scattering and increases the depth of field. The high vacuum also prevents sample contamination and allows for the use of high accelerating voltages, which can improve imaging resolution and enhance signal-to-noise ratio.

Low Vacuum Mode: This mode is suitable for imaging non-conductive samples, as the presence of a low-pressure gas reduces surface charging and enhances contrast. The low vacuum also allows for the use of lower accelerating voltages, which can reduce beam damage and increase imaging depth. The low vacuum can also enable the use of gaseous or liquid environmental chambers, which can provide in-situ observations of sample behavior.

Environmental Mode: This mode is suitable for studying dynamic processes that occur in a gas or liquid environment, such as corrosion, catalysis, and electrochemistry. The environmental chamber can provide a controlled atmosphere and temperature, which can enable the study of reaction kinetics and mechanisms. The use of specialized detectors, such as electrochemical cells or gas sensors, can also provide real-time feedback on the reaction behavior.

<u>Secondary Electron Imaging (SEI)</u>: This mode detects secondary electrons emitted from the sample surface, which are generated by the interaction of the primary electron beam with the sample surface. SEI provides information on sample topography and morphology, such as surface roughness, texture, and features.

Backscattered Electron Imaging (BEI): This mode detects backscattered electrons, which are generated by the interaction of the primary electron beam with the sample's atoms. BEI provides information on sample composition and density, as backscattered electrons are influenced by the atomic number and mass of the sample's elements.

Energy-Dispersive X-ray Spectroscopy (EDS): This mode detects X-rays emitted from the sample due to electron excitation, which can provide elemental composition analysis. EDS can provide quantitative information on the concentration and distribution of elements within the sample, as well as the identification of unknown compounds.

Energy dispersive X-ray spectroscopy (EDS) is a powerful analytical technique used in materials science, geology, metallurgy, and many other fields. EDS can provide valuable information about the composition of a material at the atomic level, allowing researchers to identify elements present in the sample and determine their relative concentrations.

Some of the key functions of EDS include:

Elemental Analysis: EDS can be used to identify and quantify the elements present in a material, even at trace levels. This information can be used to characterize the material and determine its properties, as well as to identify contaminants or impurities.

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Mapping: EDS can be used to create elemental maps of a sample, showing the distribution of different elements across the surface or within the bulk of the material. This can be useful for understanding the structure and composition of complex materials, as well as for identifying areas of interest for further analysis.

Phase Identification: EDS can be used to identify different phases or components within a material. By analyzing the elemental composition of different regions of the sample, researchers can determine the presence of different materials or phases, as well as their relative concentrations.

Chemical Bonding: EDS can provide information about the chemical bonding of elements within a material. By analyzing the energy and intensity of X-rays emitted by the sample, researchers can gain insight into the electronic structure and chemical properties of the material.

Electron Backscatter Diffraction (EBSD): This mode detects backscattered electrons that have undergone diffraction, which can provide crystallographic orientation analysis. EBSD can provide information on the grain structure and texture of the sample, as well as the identification of crystal phases and defects.

Crystallographic Analysis: EBSD can be used to determine the crystallographic structure of a material, including its lattice parameters, crystal orientation, and grain size. This information can be used to study the mechanical, thermal, and electronic properties of the material, as well as its behavior under different conditions.

Texture Analysis: EBSD can be used to analyze the texture or preferred crystallographic orientation of a material, which can affect its mechanical, thermal, and electrical properties. Texture analysis is particularly important in materials processing and manufacturing, where it is used to optimize the properties of materials for specific applications.

Defect Analysis: EBSD can be used to analyze defects in the crystal lattice of a material, including dislocations, stacking faults, and grain boundaries. Defect analysis is important for understanding the mechanical and electrical properties of materials, as well as for developing strategies to control and manipulate these properties.

Focused ion beam (FIB):

Focused ion beam (FIB) is a powerful analytical technique used in materials science, nanotechnology, and semiconductor manufacturing to prepare and analyze samples at the nanometer scale. FIB uses a focused beam of ions to interact with the sample, allowing researchers to manipulate and analyze its properties with high precision.

Some of the key functions of FIB include:

Sample Preparation: FIB can be used to prepare samples for transmission electron microscopy (TEM), scanning electron microscopy (SEM), and other analytical techniques. FIB can cut, mill, and polish samples with high precision, allowing researchers to create thin sections and prepare cross-sectional samples for analysis.

Nanofabrication: FIB can be used to create complex nanostructures and patterns on a variety of materials, including metals, semiconductors, and polymers. FIB can be used to etch or deposit material with high precision, allowing researchers to create structures with dimensions as small as a few nanometers.

Analysis: FIB can be used to analyze the properties of a sample, including its crystal structure, composition, and defects. FIB can be used in combination with other analytical techniques, such as TEM and SEM, to provide detailed information about the sample's properties.

Circuit Edit: FIB can be used to perform circuit edits on semiconductor devices, allowing researchers to modify or repair circuits with high precision. This is important for semiconductor manufacturing and for research on advanced electronics.

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LATEST DEVELOPMENTS

Recent advancements in SEM technology include aberration correction, low-voltage imaging, and environmental SEM. Aberration correction enables higher resolution imaging by correcting for the aberrations introduced by the electron lenses. Low-voltage imaging reduces the damage caused to the sample surface by the electron beam, making it possible to image more delicate samples. Environmental SEM allows for imaging of samples in their natural state, providing information about their behavior in real-world conditions.

Aberration Correction: Aberration correction involves the use of specialized electromagnetic lenses and computer algorithms to correct for aberrations in the electron beam, which can improve imaging resolution and reduce beam damage. Aberration correction can provide atomic-scale resolution in imaging and analysis, which is critical in materials science and nanotechnology.

Low-Voltage Imaging: Low-voltage imaging involves the use of low accelerating voltages, typically below 5 kV, which can reduce sample damage and increase imaging depth. Low-voltage imaging can be especially useful for imaging biological samples and soft materials, which can be easily damaged by high-energy electron beams. Low-voltage imaging can also improve the contrast and resolution of imaging, as well as provide new insights into the structure and function of materials and biological systems.

Environmental SEM: Environmental SEM involves the use of specialized environmental chambers, which can provide a controlled atmosphere and temperature for in-situ imaging and analysis of samples. Environmental SEM can be used to study dynamic processes that occur in a gas or liquid environment, such as corrosion, catalysis, and electrochemistry. Environmental SEM can also enable the use of specialized detectors and sensors, which can provide real-time feedback on the reaction behavior.

3D Imaging: Advances in imaging technology and software have enabled the development of 3D imaging and reconstruction techniques in SEM. 3D imaging can provide a more complete and accurate representation of sample morphology and structure, as well as enable quantitative analysis of sample features and properties. 3D imaging can also be used to study complex biological and geological samples, which can be difficult to analyze using traditional imaging techniques.

In-situ Analysis: Advances in sample preparation and manipulation techniques have enabled the development of in-situ analysis capabilities in SEM. In-situ analysis involves the study of samples under controlled conditions, such as temperature, pressure, and electric fields, which can provide insights into the behavior and properties of materials under different environmental conditions. In-situ analysis can be used to study a wide range of materials and phenomena, such as phase transformations, stress and strain behavior, and crystal growth.

High-Speed Imaging: High-speed imaging involves the use of specialized detectors and imaging systems to capture fast-moving phenomena in real-time. High-speed imaging can be used to study dynamic processes that occur on a millisecond or microsecond timescale, such as mechanical deformation, fluid dynamics, and chemical reactions. High-speed imaging can provide new insights into the behavior and properties of materials under extreme conditions and can help to optimize materials for specific applications.

Correlative Microscopy: Correlative microscopy involves the integration of multiple imaging and analysis techniques, such as SEM, TEM, and AFM, to provide a more complete and accurate picture of sample morphology and structure. Correlative microscopy can be used to study complex biological and geological samples, as well as materials with multiple length scales and properties. Correlative microscopy can also enable the study of dynamic processes in materials and biological systems, which can provide new insights into their behavior and function.

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Machine Learning and Artificial Intelligence: Advances in machine learning and artificial intelligence have enabled the development of automated and intelligent SEM systems. Machine learning algorithms can be used to analyze large datasets and extract meaningful information about sample properties and behavior. Machine learning can also be used to optimize imaging and analysis parameters, such as beam energy and scan speed, for specific sample types and applications. Intelligent SEM systems can provide faster and more accurate analysis, as well as enable the study of complex materials and phenomena.

In **2015, FEI Company (now Thermo Fisher Scientific)** launched a new electron microscope, the Titan Themis, which was capable of atomic-scale imaging and analysis. The Titan Themis utilized a combination of advanced optics and advanced detectors to provide exceptional imaging resolution.

In **2016**, **JEOL** released a new scanning electron microscope (SEM), the JSM-IT500HR. This SEM featured high-resolution imaging capabilities, as well as an integrated energy dispersive X-ray spectrometer (EDS) for elemental analysis.

In **2018, Hitachi High-Technologies Corporation** introduced a new SEM, the SU5000. This SEM featured a new electron gun design and a newly developed detector for improved imaging resolution and sensitivity. Additionally, the SU5000 had a new user interface for easier operation.

In **2019**, **Carl Zeiss Microscopy GmbH** introduced a new SEM, the GeminiSEM 560. This SEM utilized a new detection system for faster and more efficient imaging, as well as a new detector for improved sensitivity and resolution. The GeminiSEM 560 also featured a new user interface for improved usability.

In 2019, several Indian universities and research institutions made significant investments in scanning electron microscopes (SEM) to support their research activities. For instance, the Indian Institute of Technology Delhi purchased a new SEM equipped with a high-resolution detector for its Nanoscale Research Facility. This new SEM provides researchers with the ability to visualize samples at the sub-nanometer scale, enabling research in the fields of nanotechnology, materials science, and biological sciences. Similarly, the Indian Institute of Technology Madras invested in a new SEM equipped with an energy-dispersive X-ray spectroscope (EDS) to support research in the fields of metallurgy, materials science, and semiconductor physics. This new SEM provides researchers with the ability to perform elemental analysis, which is critical for understanding the composition of various materials.

RECOMMENDATION

Start with the basics: Before diving into the complex details, it is essential to understand the fundamental components of the SEM instrument. These include the electron source, electron lenses, sample stage, detectors, and imaging system.

Understand the Electron beam: The electron beam is the primary component of the SEM instrument, and its behavior is critical to the functioning of the instrument. Study the path of the electron beam and how it is focused and scanned across the sample surface.

Learn about Imaging and Analysis techniques: The SEM instrument offers several imaging and analysis techniques, including secondary electron imaging, backscattered electron imaging, and energy-dispersive X-ray spectroscopy. Study the schematic diagram to understand how these techniques are implemented in the instrument.

Consult Supplementary Resources: In addition to the schematic diagram, there are several resources available that can help you better understand the SEM instrument's operation. These include textbooks, online tutorials, and SEM manufacturers' technical documentation.

Practice with Real Instruments: Finally, it is essential to practice with real SEM instruments to gain hands-on experience and reinforce your understanding of the schematic

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diagram. Many academic and industrial laboratories have SEM instruments that can be used for training and research purposes.

FUTURE SCOPE

Higher Resolution Imaging: One of the most significant areas for future development in SEM technology is the improvement of resolution. With the development of more advanced electron optics, detectors, and sample preparation techniques, SEMs may achieve higher resolution, allowing scientists to observe even smaller features and details in their samples.

Time-Resolved Imaging: Another area of future development is the ability to perform timeresolved imaging using SEMs. With advanced detectors and scanning techniques, scientists may be able to observe dynamic processes in real-time, providing insight into the behavior of materials and biological systems.

In-situ Analysis: SEMs may also be used to perform in-situ analysis of materials and devices, allowing scientists to observe their behavior under different conditions. This could include analysis of materials under extreme temperatures, pressures, or other environmental factors.

Automated Data Analysis: With the increasing complexity of data generated by SEMs, the development of more advanced data analysis tools and algorithms is crucial. These tools could allow for automated analysis of large data sets, providing insights that would be difficult to obtain manually.

Integration with Other Techniques: SEMs may also be integrated with other analytical techniques, such as X-ray diffraction or spectroscopy, to provide complementary information about samples. This could lead to more comprehensive analysis of materials and devices.

CONCLUSION

In this paper, we provided a detailed study of the schematic diagram of an SEM instrument. We described the various components of an SEM instrument and their functions, including the electron source, electron column, sample chamber, electron detectors, and imaging system. We also discussed the different modes of operation of an SEM and some of the latest developments in SEM technology. SEM continues to be a powerful tool for investigating the microstructure and morphology of materials and is likely to remain a valuable instrument in many research fields in the future.

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